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FQP27P06

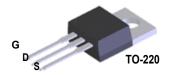
P-Channel QFET $^{\circledR}$ MOSFET - 60 V, - 27 A, 70 m Ω

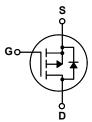
Description

This P-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- - 27 A, 60 V, $R_{DS(on)}$ = 70 m Ω (Max.) @ V_{GS} = 10 V, I_D = 13.5 A
- Low Gate Charge (Typ. 33 nC)
- Low Crss (Typ. 120 pF)
- · 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

9							
Symbol	Parameter Drain-Source Voltage			FQP27P06	Unit		
V_{DSS}				-60	V		
I _D	Drain Current	ent - Continuous (T _C = 25°C)		-27	Α		
	- Continuous (T _C = 100°C)		0°C)	-19.1	Α		
I _{DM}	Drain Current	- Pulsed	(Note 1)	-108	Α		
V_{GSS}	Gate-Source Voltage			± 25	V		
E _{AS}	Single Pulsed A	Avalanche Energy	(Note 2)	560	mJ		
I _{AR}	Avalanche Current		(Note 1)	-27	Α		
E _{AR}	Repetitive Avalanche Energy		(Note 1)	12	mJ		
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	-7.0	V/ns		
P _D	Power Dissipation (T _C = 25°C) - Derate above 25°C			120	W		
				0.8	W/°C		
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C		
T _L	Maximum lead temperature for soldering purposes,			300	°C		
	1/8" from case for 5 seconds			300			

Thermal Characteristics

Symbol	Parameter	FQP27P06	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 μA, Referenced to 25°C		-0.06		V/°C
I _{DSS}	7 0 1 1/1 5 1 0 1	V _{DS} = -60 V, V _{GS} = 0 V			-1	μА
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 150°C			-10	μА
I _{GSSF}	Gate-Body Leakage Current, Forward V _{GS} = -25 V, V _{DS} = 0 V				-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	nt, Reverse $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -13.5 A		0.055	0.07	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = -30 \text{ V}, I_D = -13.5 \text{ A}$		12.4		S
	ic Characteristics		T	T		T
C _{iss}	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$		1100	1400	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		510	660	pF
C _{rss}	Reverse Transfer Capacitance	se Transfer Capacitance		120	155	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time			18	45	ns
t _r	Turn-On Rise Time	$R_{G} = 25 \Omega$		185	380	ns
t _{d(off)}	Turn-Off Delay Time	1.6 2012		30	70	ns
t _f	Turn-Off Fall Time	(Note 4)		90	190	ns
Qg	Total Gate Charge	V _{DS} = -48 V, I _D = -27 A,		33	43	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		6.8	-	nC
Q _{gd}	Gate-Drain Charge	(Note 4)		18	-	nC
Drain-S	Source Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Did			-27	Α	
I _{SM}	Maximum Pulsed Drain-Source Diode F			-108	Α	
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -27 A			-4.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = -27 \text{ A,}$		105	-	ns
Q _{rr}	Reverse Recovery Charge dI _F / dt = 100 A/μs			0.41	-	μС

Notes:
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 0.9mH, I_{AS} = -27A, V_{DD} = -25V, R_G = 25 Ω , Starting T_J = 25°C
3. I_{SD} \leq -27A, di/dt \leq 300A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C
4. Essentially independent of operating temperature

Typical Characteristics

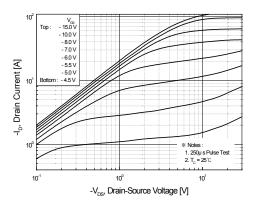


Figure 1. On-Region Characteristics

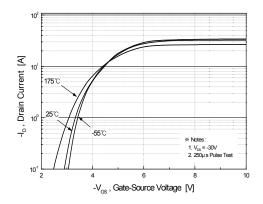


Figure 2. Transfer Characteristics

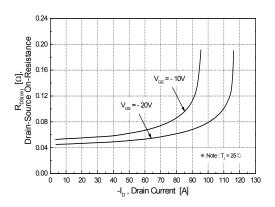


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

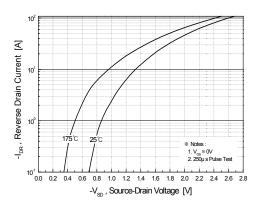


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

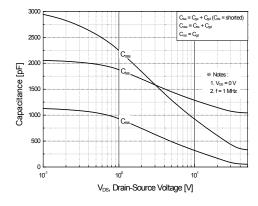


Figure 5. Capacitance Characteristics

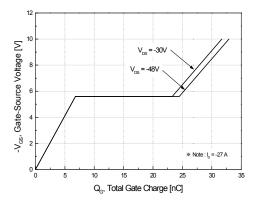
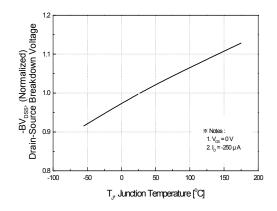


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)



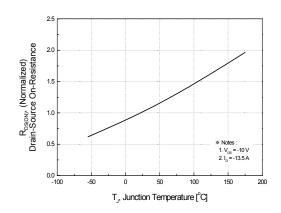
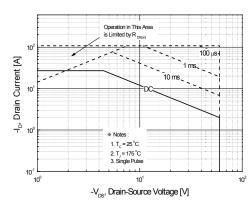


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



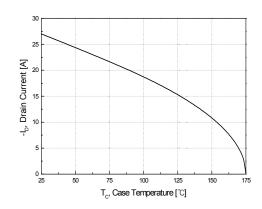


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

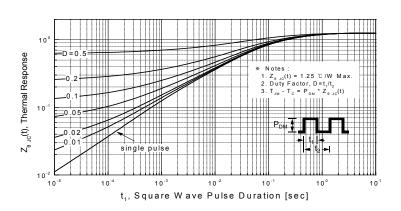
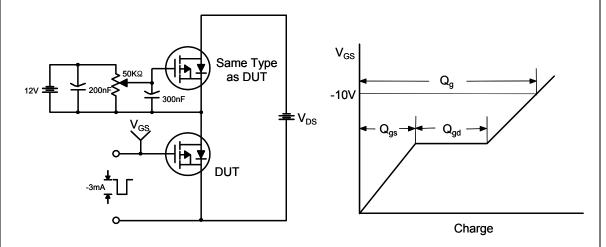
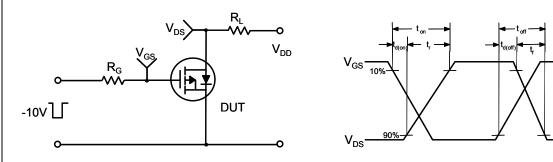


Figure 11. Transient Thermal Response Curve

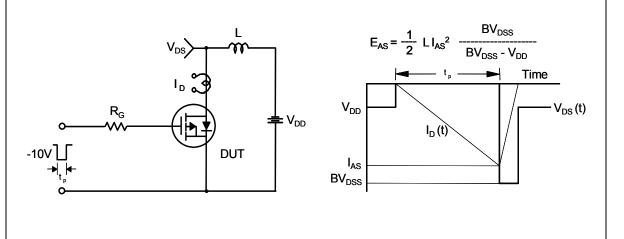
Gate Charge Test Circuit & Waveform



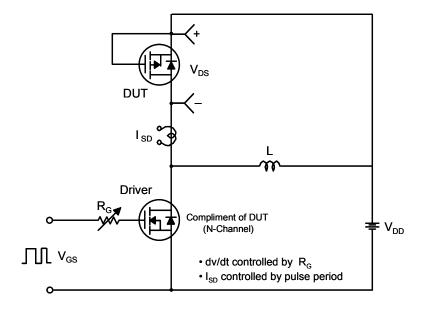
Resistive Switching Test Circuit & Waveforms

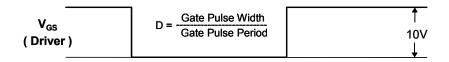


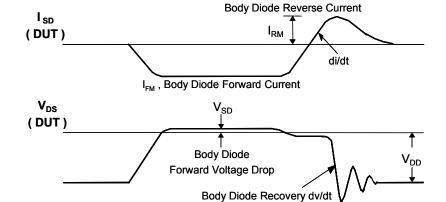
Unclamped Inductive Switching Test Circuit & Waveforms

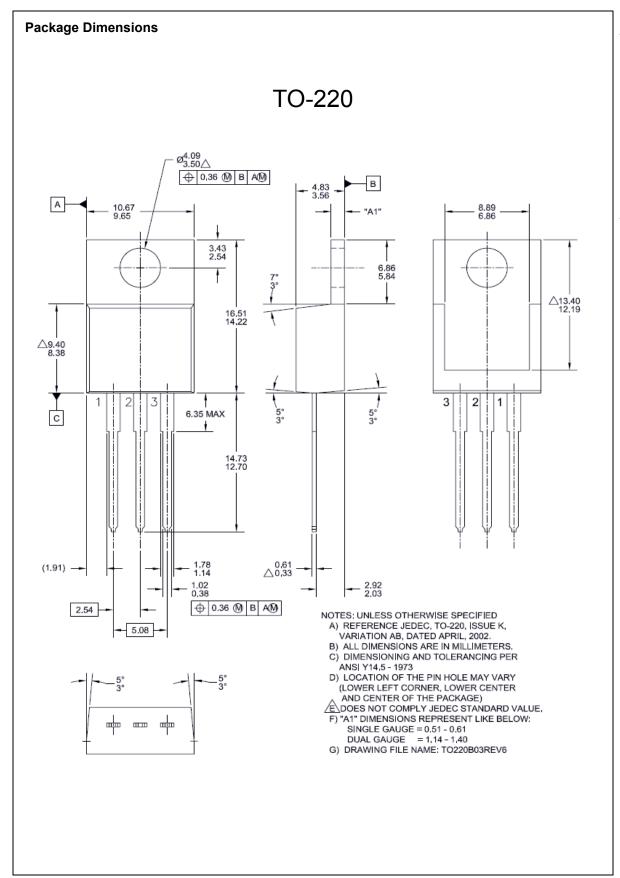


Peak Diode Recovery dv/dt Test Circuit & Waveforms









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